

Optimized-Efficiency Controller for RF Power Amplifier Boost Converter

FEATURES

- Si9160 architecture optimized for "light-load" efficiency
- High Frequency Switching (up to 2 MHz)
- Optimized Output Drive Current (300 mA)

- Standby Mode
- Wide Bandwidth Feedback Amplifier
- Single-Cell Lilon and Three-cell NiCd or NiMH Operation

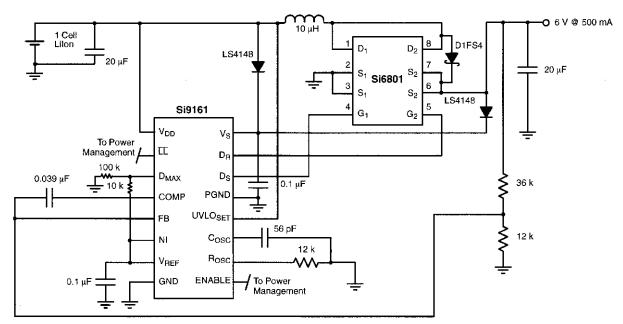
DESCRIPTION

The Si9161 Optimized-Efficiency Controller for RF Power Amplifier Boost Converter is a fixed-frequency, pulse- widthmodulated power conversion controller designed for use with the Si6801 application specific MOSFET. The Si9161 and the Si6801 are optimized for high efficiency switched-mode power conversion at 1 MHz and over. The device has an enable pin which can be used to put the converter in a low-current mode compatible with the standby mode of most cellular phones. It has a light-load pin which enables circuitry optimizing efficiency at loads typical of receive operation. A wide bandwidth feedback amplifier minimizes transient response time allowing the device to meet the instantaneous current demands of today's digital protocols. The input voltage range accommodates minimal size and cost battery pack configurations. Frequency control in switching is important to noise management techniques in RF communications. The Si9161 is easily synchronized for high efficiency power conversion at frequencies in excess of 1 MHz.

Optimizing the controller and the synchronous FETs results in the highest conversion efficiency over a wide load range at the switching frequencies of interest (1 MHz or greater). It also minimizes the overshoot and gate ringing associated with drive current and gate charge mismatches.

When disabled, the converter requires less than 330 μ A. This capability minimizes the impact of the converter on battery life when the phone is in the standby mode.

Finally, operating voltage is optimized for Lilon battery operation (2.7 V to 4.5 V) and can also be used with three-cell NiCd or NiMH (3 V to 3.6 V), as well as four-cell NiCd or NiMH (4 V to 4.8 V) battery packs.



APPLICATION CIRCUIT



ABSOLUTE MAXIMUM RATINGS

Voltages Referenced to GND.

· ·····9······
$V_{DD},V_{S}.\ldots.................$
P _{GND} ±0.3 V
Linear Inputs
Logic Inputs
Peak Output Drive Current
Storage Temperature

Operating Junction Temperature
Power Dissipation (Package) ^a 16-Pin TSSOP (Q Suffix) ^{a, b}
Thermal Impedance (Θ _{JA}) ^a 16-Pin TSSOP135°C/W
Notes
a. Device mounted with all leads soldered or welded to PC board.

b. Derate 7.4 mW/°C above 25°C.

Exposure to Absolute Maximum rating conditions for extended periods may affect device reliability. Stresses above Absolute Maximum rating may cause permanent damage. Functional operation at conditions other than the operating conditions specified is not implied. Only one Absolute Maximum rating should be applied at any one time.

	Symbol	$\begin{tabular}{lllllllllllllllllllllllllllllllllll$		Limits B Suffix -25 to 85°C				
Parameter				Min ^b	Тур	Max ^b	Unit	
Reference		•						
Output Voltage	V _{REF}	I _{REF} = -10 μA 1.455 TA = 25°C 1.477		1.455		1.545	V	
				1.50	1.523	· · ·		
Oscillator								
Maximum Frequency ^c	f _{MAX}	V_{DD} = 5 V, C_{OSC} = 47 pF, R_{OSC} = 5.0 k Ω		2.0			MHz	
Oscillator Frequency Accuracy		V_{DD} = 3.0 V, f _{OSC} = 1 MHz (nominal) C _{OSC} = 100 pF, R _{OSC} = 7.0 kΩ, T _A = 25°C		-15		15	%	
R _{OSC} Peak Voltage	V _{ROSC}				1.0		V	
Voltage Stability ^c	Δf/f	4 V \leq V $_{DD}$ \leq 6 V, Ref to 5 V, T_A = 25 $^{\circ}\text{C}$		-8		8	%	
Temperature Stability ^c	Δ1/1	Referenced to 25°C			±5			
Light-Load Frequency ^c	f	$\overline{\text{LL}}$ = 0 V, C _{OSC} = 100 pf, R _{OSC} = 7.0 k Ω			115		kHz	
Error Amplifier (C _{OSC} =	GND, OSC Dis	sabled)						
Input Bias Current	ا _B	$V_{NI} = V_{REF}, V_{FB} = 1.0 V$		-1.0		1.0	μA	
Open Loop Voltage Gain	A _{VOL}			47	55		dB	
Offset Voltage	V _{OS}	$V_{NI} = V_{REF}$		-15	0	15	mV	
Unity Gain Bandwidth ^c	BW				10		MHz	
Output Current	I _{OUT}	Source (V _{FB} = 1 V, NI = V _{REF})			-2.0	-1.0	mA	
		Sink (V _{FB} = 2 V, NI = V _{REF})		0.4	0.8			
Power Supply Rejection ^c	PSRR	4 V < V _{DD} < 6 V			60		dB	
UVLO _{SET} Voltage Monite	or							
Under Voltage Lockout	V _{UVLOHL}	UVLO _{SET} High to L	_ow	0.85	1.0	1.15	V	
	V _{UVLOLH}	UVLO _{SET} Low to H	ligh		1.2		Ů	
Hysteresis	V _{HYS}	V _{UVLOLH} - V _{UVLOHL}			200		mV	
UVLO Input Current	I _{UVLO(SET)}	$V_{UVLO} = 0$ to V_{DD}		-100		100	nA	



SPECIFICATIONS							
		Test Conditions Unless Otherwise Specified ^a		Limits B Suffix -25 to 85°C			
Parameter	Symbol	$\overline{\text{LL}} = \text{V}_{\text{DD}}, 2.7 \text{ V} \le \text{V}_{\text{DD}}, \text{V}_{\text{S}} \le 6.0$		Min ^b	Тур	Max ^b	Unit
Output Drive (D _R and D _S)							
Output High Voltage	V _{OH}	V _{DD} = 2.7 V V _S = 5.3 V	I _{OUT} = -10 mA	5.15	5.2		V
Output Low Voltage	V _{OL}	v _S = 5.3 v	I _{OUT} = 10 mA		0.06	0.15	
Peak Source Output Current	ISOURCE	V _{DD} = 2.7 V	V _S = 5.3 V		-300	-250	mA
Peak Sink Output Current	I _{SINK}	$v_{DD} = 2.7 v$	V _S = 5.3 V	250	300		
Break-Before-Make	t _{BBM}	V _{DD} = 6.0 V			40		ns
Logic	•						
ENABLE Delay to Output	td _{EN}	ENABLE Rising to OUTPUT	ENABLE Rising to OUTPUT, V _{DD} = 6.0 V		1.4		μs
ENABLE Logic Low	V _{ENL}					0.2 V _{DD}	V
ENABLE Logic High	V _{ENH}			0.8 V _{DD}			v
ENABLE Input Current	I _{EN}	ENABLE = 0 to V_{DD}		-1.0		1.0	μA
Light Load Delay to Output ^c	td	Light Load Falling to OUTPUTS			1.4		μs
Light Load Logic Low	$V_{\overline{LLL}}$					0.8	V
Light Load Logic High	V			2.4			V
Light Load Input Current	I	$\overline{LL} = 0$ to V _{DD}		-1.0		1.0	μA
Duty Cycle	•						
Maximum Duty Cycle	CYCLE _{MAX}	V _{DD} = 6.0 V			80	95	%
D _{MAX} /SS Input Current	I _{DMAX}	$D_{MAX} = 0$ to V_{DD}		-100		100	nA
Supply	•			•		•	
Supply Current—Normal		No Load, V _{LL} = 0 to V _{DD}	$V_{DD} = 2.7 V$		1.1	1.5	
Mode	I _{DD}	$f_{OSC} = 1 \text{ MHz}, R_{OSC} = 7.0 \text{ k}\Omega$	V _{DD} = 4.5 V		1.6	2.3	mA
Supply Current—Standby Mode	טטי	ENABLE = Low			250	330	μA

Notes

a. C_{STRAY} < 5 pF on C_{OSC}. After Start-Up, V_{DD} of \geq 3 V.

b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.

c. Guaranteed by design, not subject to production testing.



100

0

-30

-60

-90

-120

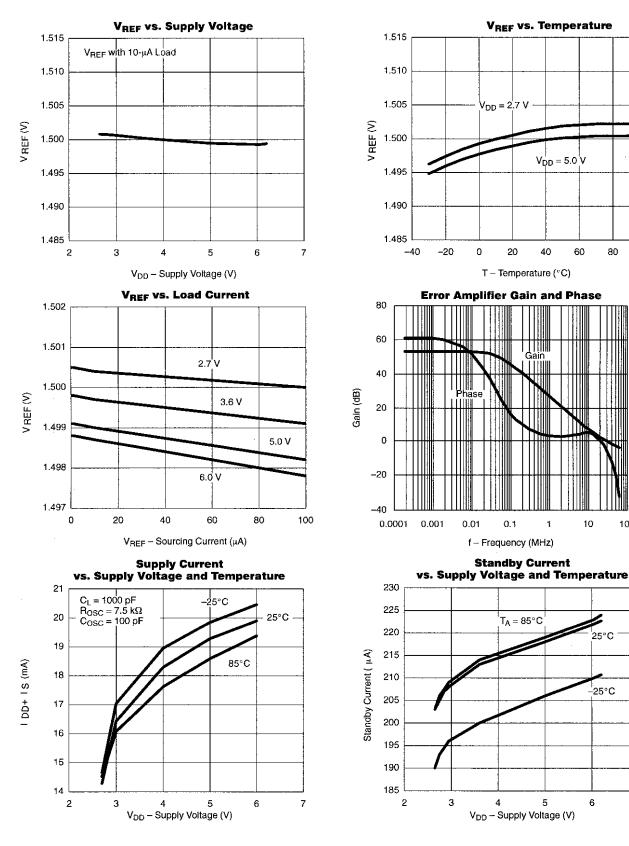
-150

100

7

Phase (deg)

TYPICAL CHARACTERISTICS ($\overline{LL} = V_{DD}$, 25°C UNLESS OTHERWISE NOTED)





DR

6

4.98 kΩ $12.07 \ k\Omega$

24.88 kΩ 49.7 kΩ

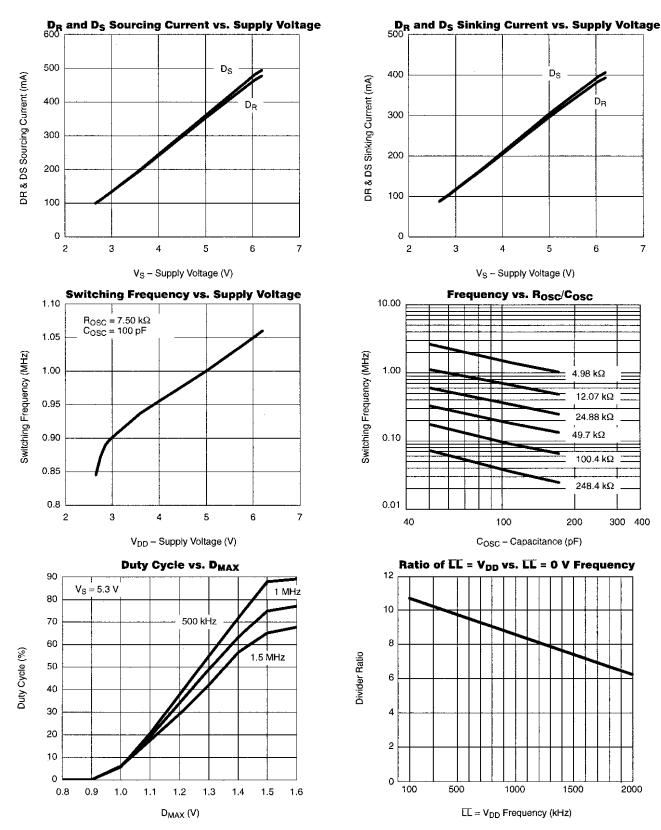
100.4 kΩ

. 248.4 kΩ

300 400

7





FaxBack 408-970-5600, request 70747 www.siliconix.com

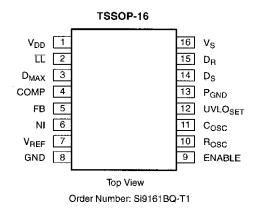
2000

Si9161

Vishay Siliconix



PIN CONFIGURATIONS



PIN DESCRIPTION

Pin 1: V_{DD}

The positive power supply for all functional blocks except output driver. A bypass capacitor of 0.1 μF (minimum) is recommended.

Pin 2: LL

A logic high on this pin allows normal operation. A logic low places the chip in light-load optimized-efficiency mode. In light-load mode, the oscillator frequency is reduced and D_R goes high, disabling synchronous rectification. Do not leave pin unconnected.

Pin 3: D_{MAX}

Used to set the maximum duty cycle.

Pin 4: COMP

This pin is the output of the error amplifier. A compensation network is connected from this pin to the FB pin to stabilize the system. This pin drives one input of the internal pulse width modulation comparator.

Pin 5: FB

The inverting input of the error amplifier. An external resistor divider is connected to this pin to set the regulated output voltage. The compensation network is also connected to this pin.

Pin 6: NI

The non-inverting input of the error amplifier. In normal operation it is externally connected to ${\rm V}_{\rm REF}$ or an external reference.

Pin 7: V_{REF}

This pin supplies a 1.5-V reference.

Pin 8: GND (Ground)

Pin 9: ENABLE

A logic high on this pin allows normal operation. A logic low places the chip in the standby mode. In standby mode, normal operation is disabled, supply current is reduced, the oscillator stops, and D_S goes low while D_R goes high.

Pin 10: ROSC

A resistor connected from this pin to ground sets the oscillator's capacitor (C_{OSC}) charge and discharge current. See the oscillator section of the description of operation.

Pin 11: COSC

An external capacitor is connected to this pin to set the normal oscillator frequency.

$$f_{OSC} \cong \frac{0.70}{R_{OSC} \times C_{OSC}} \qquad (at \ V_{DD} = 5.0 \ V)$$

Pin 12: UVLO_{SET}

This pin will place the chip in the standby mode if the UVLO_{SET} voltage drops below 1.2 V. Once the UVLO_{SET} voltage exceeds 1.2 V, the chip operates normally. There is a built-in hysteresis of 200 mV.

Pin 13: P_{GND}

The negative return for the V_S supply.

Pin 14: D_S

This CMOS push-pull output pin drives the external n-channel MOSFET. This pin will be low in the standby mode. A breakbefore-make function between D_S and D_R is built-in.



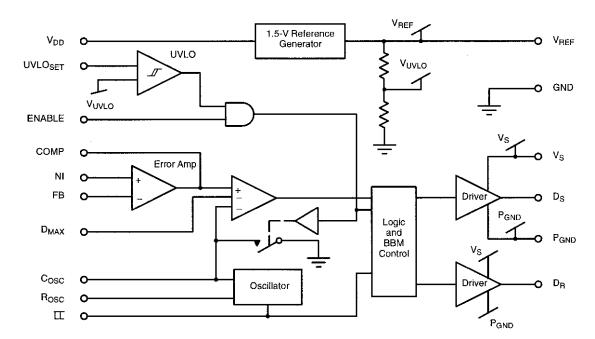
Si9161 Vishay Siliconix

Pin 15: D_R

Pin 16: V_S

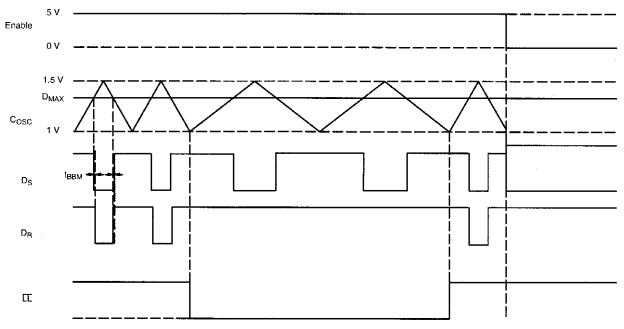
This CMOS push-pull output pin drives the external p-channel MOSFET. This pin will be high in the standby and light-load modes. A break-before-make function between the D_S and D_R is built-in.

The positive terminal of the power supply which powers the CMOS output drivers. A bypass capacitor is required.



FUNCTIONAL BLOCK DIAGRAM

TIMING WAVEFORMS



Note: Timing waveforms are not to scale.



OPERATION OF THE Si9161 BOOST CONVERTER

The Si9161 combined with optimized complementary MOSFETs provides the ideal solution to small, high efficiency, synchronous boost power conversion. Optimized for a 1-cell lithium ion, or 3-cell to 4-cell Nickel metal hydride battery, it is capable of switching at frequencies of up to 2 MHz. Combined with the Si6801, a complimentary high-frequency MOSFET, efficiencies of over 90% are easily achieved in a very small area; with light-load mode, efficiency over 80% can be achieved at power less than 1/2 W.

PWM Controller

The Si9161 implements a user-selectable synchronous/nonsynchronous voltage mode PWM control topology and is especially designed for battery power conversion. Voltagemode control results in the most efficient power conversion solution. Figure 1 below illustrates a schematic for a synchronous boost converter with an input range of 2.7 V to 5 V which covers the range of 1-cell Lilon and 3-cell or 4-cell NiMH/NiCd battery input respectively, and an output voltage of 5 V. Note the maximum input voltage is limited to the output voltage for a boost converter.

The switching frequency is determined by an external capacitor and resistor connected to C_{osc} and R_{osc} pins. The graph on page 5 in the Typical Characteristics section shows the typical C_{osc} and R_{osc} values for various switching frequency. Si9161 oscillator frequency can be easily synchronized to external frequency as long as external switching frequency is higher than the internal oscillator frequency. The synchronization circuit is a series resistor and capacitor fed into the C_{osc} pin of the Si9161. The synchronization pulse should be greater than 1.5 V in amplitude and a near square wave pulsed clock. Figure 1 shows typical values for the synchronization components.

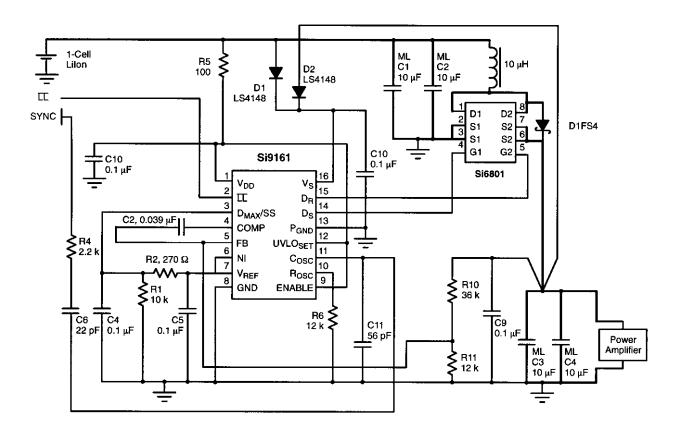


FIGURE 1. Si9161 Boost Converter



Startup

Designed to operate with single cell Lithium Ion battery voltage, the Si9161 has an operating range of 2.7 V to 6.0 V. During start-up, the device requires 3.0 V to guarantee proper operation, although it will typically start up at less than 2.2 V. Once powered, Si9161 will continue to operate until the voltage at V_{DD} is 2.7 V; at this point, the battery is basically dead. During start-up, power for the chip is provided by the battery through R5 to V_{DD} and through schottky diode D1 to V_S pins. Once the converter is fully operating, V_S supply power is provided by the converter output through diode D2, which overrides the D1 diode. This self perpetuating method of powering further improves the converter efficiency by utilizing higher gate drive to lower the on-resistance loss of the MOSFET.

Another benefit of powering from the output voltage is it provides minimum load on the converter. This prevents the converter from skipping frequency pulses typically referred to as Burst or Pulse-Skipping modes. Pulse skipping mode could be dangerous, especially if it generates noise in RF, IF, or signal processing frequency bands.

Enable and Under Voltage Shutdown

The Si9161 is designed with programmable under-voltage lockout and enable features. These features give designers flexibility to customize the converter design. The under-voltage lockout threshold is 1.2 V. With a simple resistor divider from V_{DD} , Si9161 can be programmed to turn-on at any V_{DD} voltage. The ENABLE pin, a TTL logic compatible input, allows remote shutdown as needed.

Gate Drive and MOSFETs

The gate drive section is designed to drive the high-side p-channel switch and low-side n-channel switch. The internal 40 ns break-before-make (BBM) timing prevents both MOSFETs from turning-on simultaneously. The BBM circuit monitors both drive voltages, once the gate-to-source voltage drops below 2.5 V, the other gate drive is delayed 40-ns before it is allowed to drive the external MOSFET (see Figure 2 for timing diagram). This smart gate drive control provides additional assurance that shoot-through current will not occur.

Si9161 Vishay Siliconix

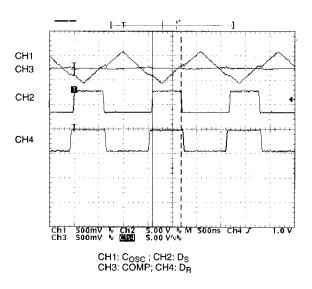
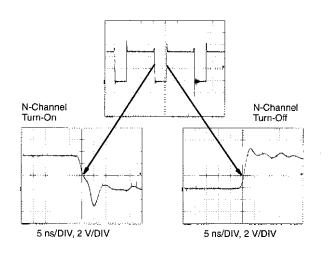


FIGURE 2. Gate Drive Timing Diagrams

The MOSFET used is the Si6801, an n- and p-channel in a single package TSSOP-8. The Si6801 is optimized to have very low gate charge and gate resistance. This results in a great reduction in gate switching power losses. The average time to switch on and off a MOSFET in a conventional structure is about 20 ns. The Si6801 will switch on and off in <5 ns, see Figure 3.



Note the Speed

These MOSFETs have switching speeds of <5 ns. This high speed is due to the fast, high current output drive of the Si9161 and the optimized gate charge of the Si6801.

FIGURE 3. Gate Switching Times

Stability Components

A voltage mode boost converter is normally stabilized with simple lag compensation due to the additional 90° phase lag introduced by the additional right hand plane zero, as well as having a duty factor dependent resonant frequency for the output filter. The stability components shown in Figure 1 have been chosen to ensure stability under all battery conditions while maintaining maximum transient response. To do this we have used simple lag compensation (type 1 amplifier configuration). Figure 4 shows the bode plot for the above circuit, maintaining > 50° phase margin over the entire battery voltage range.

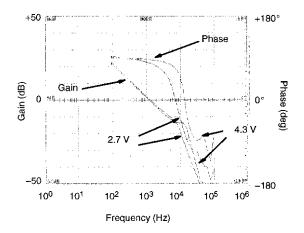
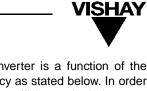


FIGURE 4. Stability, with 1-cell Li battery input, 5 V @ 600-mA output.

Energy Storage Components

The input and output ripple voltage is determined by the switching frequency, and the inductor and capacitor values. The higher the frequency, inductance, or capacitance values, the lower the ripple. The efficiency of the converter is also improved with higher inductance by reducing the conduction loss in the switch, synchronous rectifier, and the inductor itself. In the past, Tantalum was the preferred material for the input and output capacitors. Now, with 2-MHz switching frequencies, Tantalum capacitors are being replaced with smaller surface mount ceramic capacitors. Ceramic capacitors have almost no equivalent series resistance (ESR). Tantalum capacitors have at least $0.1-\Omega$ ESR. By reducing ESR, converter efficiency is improved while decreasing the input and output ripple voltage. With ceramic capacitors, output ripple voltage is a function of capacitance only. The equation for determining output capacitance is stated below.

$C = \frac{I_{OUT} \cdot (V_{OUT} - V_{IN})}{V_{OUT} \cdot \Delta V_{RIPPLE} \cdot f}$				
I _{OUT} V _{OUT} V _{IN} ΔV _{RIPPLE} f	= = = =	output dc load current output voltage input voltage desired output ripple voltage switching frequency		



The inductance value for the converter is a function of the desired ripple voltage and efficiency as stated below. In order to keep the ripple small and improve efficiency, the inductance needs to be large enough to maintain continuous current mode. Continuous current mode has lower RMS current compared to discontinuous current mode since the peak current is lower. This lowers the conduction loss and improves efficiency. The equation that shows the critical inductance which separates continuous and discontinuous current mode at any given output current is stated below. This equation is also plotted in Figure 5 as a function of input voltage.

$$L = \frac{V_{IN}^2 \cdot (V_{OUT} - V_{IN}) \cdot \eta}{2 \cdot V_{OUT}^2 \cdot I_{OUT} \cdot f}$$

 $\eta = efficiency$

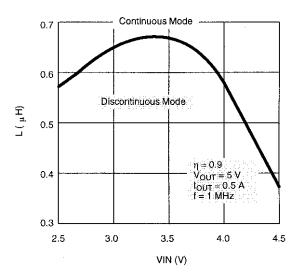


FIGURE 5. Continous and Discontinous Inductance Curve

Designed with small surface mount inductors and capacitors, the Si9161 solution can fit easily within a small space such as a battery pack. Another distinct advantage of a smaller converter size is that it reduces the noise generating area by reducing the high current path; therefore radiated and conducted noise is less likely to couple into sensitive circuits.

RESULTS SECTION

The following section shows the actual results obtained with the circuit diagram shown in Figure 1.

Efficiency

The graph below shows the efficiency of the above design at various constant switching frequencies. The frequencies were generated using a 3-V square wave of the desired frequency to the sync input to the circuit. The input voltage to the circuit is 3.6-V dc.



Si9161 Vishay Siliconix

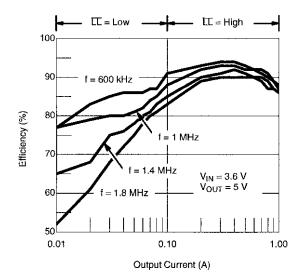
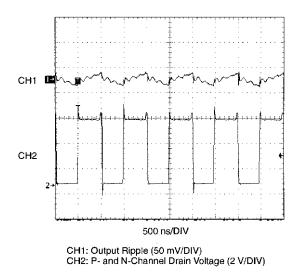
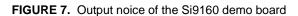


FIGURE 6. Efficiency of Si9161 and Si6801 Boost converter at various fixed frequencies





Output Noise

The noise generated by a dc-dc converter is always an issue within the mobile phone. The Si9161 offers two benefits.

- 1. The noise spectrum is a constant, i.e. no random noise or random harmonic generation.
- 2. The switching fundamental can be synchronized to a known frequency, e.g. 812.5 kHz which is 1/16-th of the GSM/DCS system clock, or 1.23 MHz which is the channel spacing frequency for CDMA, etc.

Figures 7 through 9 show the output noise and output spectrum analysis.

Output Noise Spectrum

Note there is no random noise, only switching frequency harmonics. This is very good news for the RF stages, where an unknown, or random noise spectrum will cause problems.

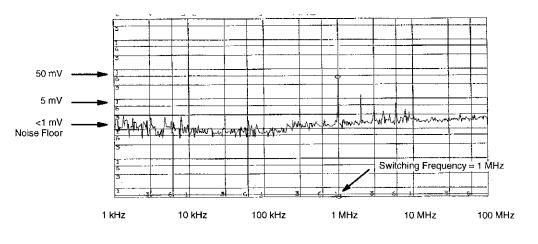


FIGURE 8. Spectrum response for the Si9161 demo board output voltage



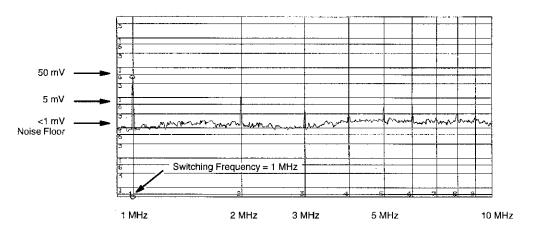


FIGURE 9. Higher resolution of noise spectrum

Conclusion

Switching at high, known frequencies results in a smaller footprint while maintaining high efficiency. Efficiencies at high switching frequencies can be improved by using Si6801 optimized low gate charge and low gate resistance MOSFET.

Even though the high frequency MOSFET has been designed with minimum gate charge, it still presents significant power loss during the light load conditions. In order to minimize this switching loss, Si9161 is designed with a light load efficiency improvement pin which decreases the switching frequency by 8.5 times (@ 1 MHz) and disables the synchronous rectification. This feature improves the light load efficiency in certain conditions as much as 50% compare to Si9160. Additionally, under transmitting mode, Si9161 clock frequency can be synchronized to higher external frequency which eliminates or greatly reduces any radio interference concerns and pushes harmonics out beyond signal processing frequencies.



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.



Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию.

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России, а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научноисследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург, Промышленная ул, дом № 19, литера Н, помещение 100-Н Офис 331